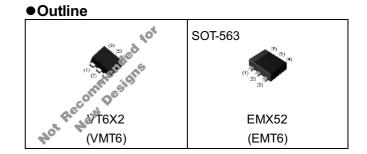


# VT6X2 / EMX52

Power management (dual transistors)

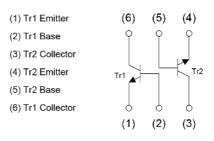
Datasheet

Parameter	Tr1 and Tr2
V <sub>CEO</sub>	50V
Ι <sub>C</sub>	100mA



# Features

- 1) General Purpose.
- 2) Two 2SCR523 chips in one package.
- 3) Transister elements are independent, eliminating interface.
- 4) Mounting cost and area can be cut in half.



Inner circuit

# Application

SWITCH, LED DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
VT6X2	(VMT6)	1212	T2R	180	8	8000	X2
EMX52	SOT-563 (EMT6)	1616	T2R	180	8	8000	X52

# • Absolute maximum ratings (T<sub>a</sub> = 25°C)

<It is the same ratings for the Tr1 and Tr2>

Parameter			ool Values	Unit
Collector-base voltage			<sub>ю</sub> 50	V
Collector-emitter voltage			io 50	V
Emitter-base voltage			o 5	V
			100	mA
Collector current		ا <sub>CP</sub> *	200	mA
Power dissipation VT6X2		*2	*3 150	
	EMX52	P <sub>D</sub> *2	150	mW
Junction temperature			150	°C
Range of storage temperature			-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

< It is the same characteristics for the Tr1 and Tr2>

Deremeter	Sumbol	Conditions	Values			Unit	
Parameter	Symbol	ol Conditions –		Min. Typ.		Onit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	<sub>CBO</sub> Ι <sub>C</sub> = 50μΑ		-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	-	V	
Emitter-base breakdown voltage	$BV_{EBO}$	Ι <sub>Ε</sub> = 50μΑ	5	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	-	100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 5V	-	-	100	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 50mA, I <sub>B</sub> = 5mA	-	100	300	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 6V, I <sub>C</sub> = 1mA	120	-	560	-	
Transition frequency	f⊤	V <sub>CE</sub> = 10V, I <sub>E</sub> = -10mA, f = 100MHz	-	350	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	1.6	-	pF	

\*1 Pw=10ms Single Pulse

\*2 Each terminal mounted on a reference land.

\*3 120mW per element must not be exceeded.



<For Tr1 and Tr2 in common>



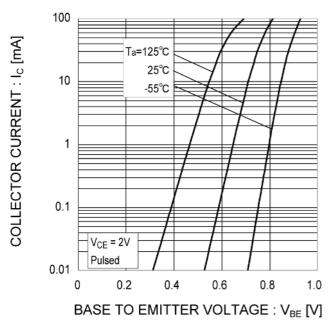


Fig.3 DC Current Gain vs. Collector Current (I)

1

COLLECTOR CURRENT : Ic [mA]

10

Ta=125°C 25°C -55°C

1000

100

10

0.1

DC CURRENT GAIN : hFE

Fig.4 DC Current Gain vs. Collector Current (II)

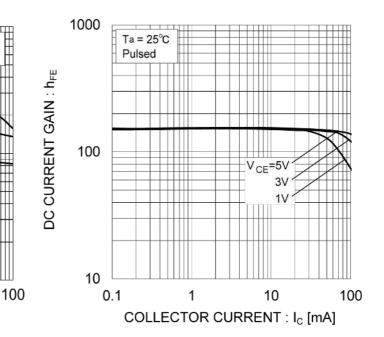
1

Ta = 25°C Pulsed

COLLECTOR TO EMITTER VOLTAGE : V<sub>CE</sub> [V]

3

2



## Fig.2 Typical Output Characteristics

450μΑ 400μΑ

500µA

50

40

30

20

10

0

COLLECTOR CURRENT : I<sub>C</sub> [mA]

350µA

300µA

250µA

200µA

150µA

100µA

50μΑ

IB=0A

5

4

Datasheet



 $V_{CE} = 5V$ 

Pulsed

1

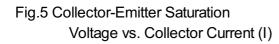
 $I_C/I_B = 10$ 

Pulsed

100

# • Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>



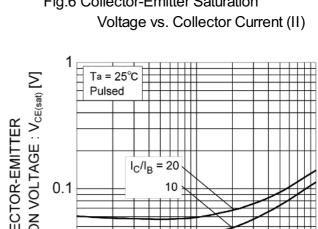


Fig.6 Collector-Emitter Saturation

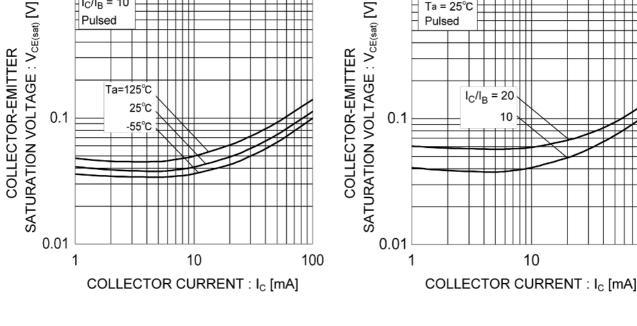
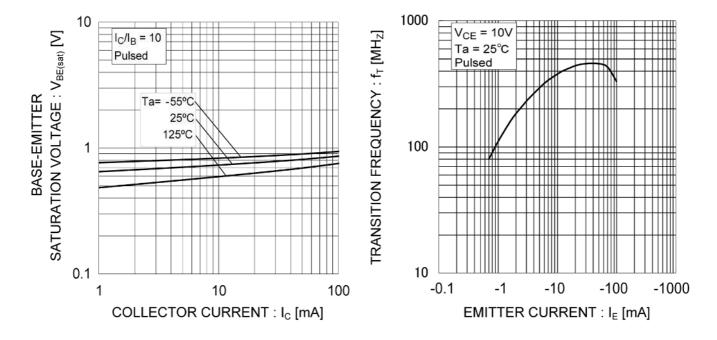


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

Fig.8 Gain Bandwidth Product vs. **Emitter Current** 

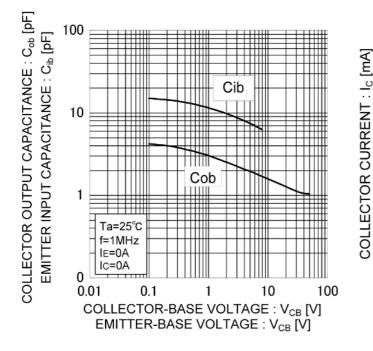
10



## •Electrical characteristic curves (T<sub>a</sub> =25°C)

<For Tr1 and Tr2 in common>

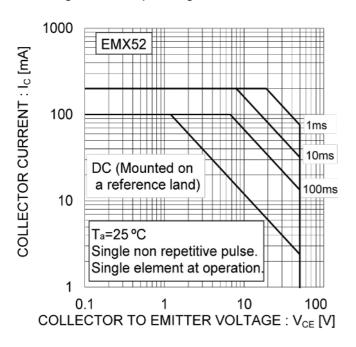
Fig.9 Emitter Input Capacitance vs. Emitter-Base Voltage Collector Output Capacitance vs. Collector-Base Voltage



1000 VT6X2 100 1ms 10ms DC (Mounted on a reference land) 100ms 10 T₂=25 °C Single non repetitive pulse. Single element at operation. 1 100 0.1 1 10 COLLECTOR TO EMITTER VOLTAGE : V<sub>CE</sub> [V]

Fig.10 Safe Operating Area

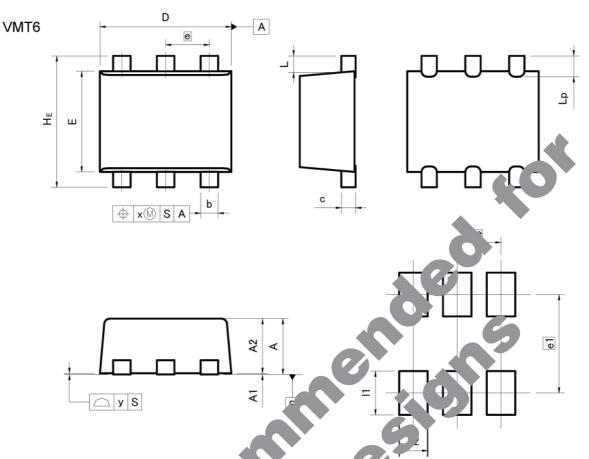
Fig.11 Safe Operating Area





ROHM

## Dimensions



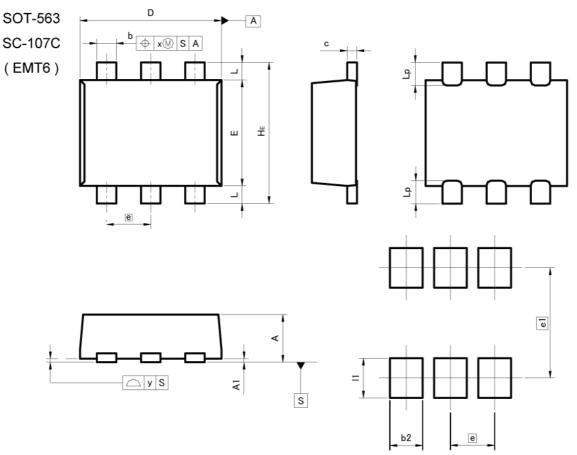
Fattern of terminal position areas [Not a pattern of soldering pads]

	DIM		LIMETERS		HES	
	191227-0017	Nurv	N X	MIN	MAX	
	A	0.42		0.017	0.024	
	Ĵ,	0.00	05	0.000	0.002	
		0.40	U.60	0.016	0.024	
	b	0.40	0.21	0.004	0.008	
	С	- 0.0.	0.18	0.003	0.007	
	D	טי	1.30	0.043	0.051	
	E	0.	1.02	0.032	0.04	
	е	0.40		0.016		
	HE	1.10	1.30	0.043	0.051	
	L	0.14		0.0	0.006	
	Lp	0.10	0.30	0.004	0.012	
	x	I	0.05	Ŧ	0.002	
	У	and the second s	0.10	1	0.004	
	DIM	MILIM	ETERS	INCHES		
	DIM	MIN	MAX	MIN	MAX	
	b2		0.26	1	0.010	
	e1	0.90		0.035		
	11	225	0.40	1200	0.016	

Dimension in mm/inches



### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
с	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	-	0.35	-	0.014	
x	<u>a</u> n	0.10	<u> </u>	0.004	
у	<del>as</del> i i	0.10		0.004	
DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2		0.37		0.015	
e1	1.:	25	0.0	49	
11	-	0.45	-	0.018	

Dimension in mm/inches



# Notice

#### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (<sup>Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the S	pecific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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